## PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Xiangdong Chen	04/24/2011
Weipeng Li	04/21/2011
Dae-Gyu Park	03/21/2011
Melanie J. Sherony	03/24/2011

## **RECEIVING PARTY DATA**

Name:	International Business Machines Corporation	
Street Address:	New Orchard Road	
City:	Armonk	
State/Country:	NEW YORK	
Postal Code:	10504	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number	
Application Number:	13094873	

## **CORRESPONDENCE DATA**

Fax Number: (845)892-6363

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 410-705-6400 Email: md@us.ibm.com

Correspondent Name: FREDERICK W. GIBB, III Gibb Intellectual

Address Line 1: 844 West Street
Address Line 2: SUITE 100

Address Line 4: ANNAPOLIS, MARYLAND 21401

ATTORNEY DOCKET NUMBER: FIS920110009US1

NAME OF SUBMITTER: Yuanmin Cai

Total Attachments: 6

PATENT REEL: 026185 FRAME: 0224 00 1309487

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PATENT REEL: 026185 FRAME: 0225

# **ASSIGNMENT**

Whereas, the undersigned inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention: HIGH PRESSURE DEUTERIUM TREATMENT FOR SEMICONDUCTOR/HIGH-K INSULATOR INTERFACE

in and to any and all patent applications and patents directed thereto;

and further identified by the IBM Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:			
Serial Number:	(insert series code and serial number here if/when available)		
business at Armonk. New York	is Machines Corporation, a corporation of New York having a place of therein referred to as "IBM"), desires to acquire, and each undersigned I, the entire worldwide right, title, and interest in and to the Invention and		

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives,

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

[Inventor Signature Page(s) Follows]

Page 1 of 2

	Executed by Inventor 1
Signature:	Miandong Chen (C) Xiangdong Chen
	Executed by Inventor 2
Signature:	Weipeng Li
	Executed by Inventor 3
Signature:	Date: Date:
	Executed by Inventor 4
Signature:	Melanic J. Sherony

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[Inventor Signature Page(s) Follows]

Executed by Inventor 1			
Signature: _	Xiandong Chen	Date:	
	Exec	ecuted by Inventor 2	
Signature: _	Weipeng Li	Date: 4-21-2011	
	Exe	ecuted by Inventor 3	
Signature: _	Dae-Gyu Park	Date:	
	Exe	ecuted by Inventor 4	
Signature: _	Melanie J. She Melanie J. Sherony	erony Date: 3/24/11	

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[Inventor Signature Page(s) Follows]

# Executed by Inventor 2

(2)	Name of Inventor: Laegu Kang	
	Signature:	Date
	Citizenship: US	
	Executed by Inventor 3	
(3)	Name of Inventor: Weipeng Li	
	Signature:	Date
	Citizenship: CN	
(4)	Executed by Inventor 4  Name of Inventor: Dae-Gyu Park	
	Signature: My fark	3/21/2011 Date
	Citizenship: KR	
	Executed by Inventor 5	
(5)	Name of Inventor: Melanie J. Sherony	
	Signature:	Date
	Citizenship: US	

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